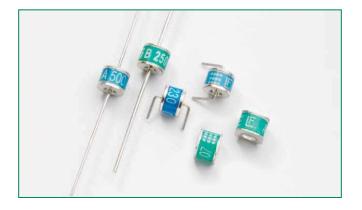
RoHS 🗭 SL1011A/B and SL1411A Series



Agency Approvals

AGENCY	AGENCY FILE NUMBER
<i>L</i> R _®	E128662

2 Electrode GDT Graphical Symbol

ittelfuse

Expertise Applied | Answers Delivered



Description

The SL1011A/B and SL1411A series provides high levels of protection against fast rising transients in the $100V/\mu$ s to $1kV/\mu$ s range usually caused by lightning disturbances.

The SL1011A/B and SL1411A series offers low capacitance (< 1.5pf) which provides low insertion loss at high frequencies.

SL1011A offers 5kA protection without destruction whereas the SL1011B and SL1411A offer 10kA surge protection without destruction (maximum single surge of 12kA @ $8/20\mu$ s).

Features

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 5kA (SL1011A) or 10kA (SL1011B & SL1411A) surge capability tested with 8/20µs pulse as defined by IEC 61000-4-5

Applications

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- General telecom equipment

R

Gas Discharge Tube (GDT) Products SL1011A/B and SL1411A Series



Electrical Characteristics

	Device Specifications (at 25°C)					Life Ratings									
Part Number	ir	Breakc Volts @100V/	1,2	Impulse Breakdown in Volts ³ (@100V/µs)	Impulse Breakdown In Volts (@1kV/µs)	Insulation Resistance		Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@100A 10/1000µs)	Nominal Impulse Discharge Current (8/20µs)	Nominal AC Discharge Current (10x1s @50-60Hz)	AC Dischage Current (9 Cycles @ 50Hz)	DC Holdover Voltage⁴	Discharg	npulse e Current lication)
	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP	@ 8/20µs	@ 10/350µs
SL1011A075															
SL1011B075	60	75	90	500	700										
SL1411A075						10 ¹⁰ Ω (at 50V)							50 V		
SL1011A090		90	108	500	600										
SL1011B090	72														
SL1411A090															
SL1011A145	116	145	174	500	650										
SL1011B145						-									
SL1011A150 SL1011B150	120	150	180	500	650										
SL1011B150										SL1011A:					
SL1011B230	184	230	276	550	700					10 shots	SL1011A:	SL1011A:			
SL1411A230	104	+ 230	210	.70 000		10 ¹⁰ Ω - (at 100V)	1.5 pF	~20 V	300 shots	(@5kA)		20 A SL1011B & SL1411A: 65 A	105.14	SL1011B & SL1411A: 12 kA	1 kA
SL1011A250										SL1011B & SL1411A: 10 shots (@10kA)					
SL1011B250	200	250	300 600	600	800										
SL1411A250															
SL1011A260				310 600											
SL1011B260	210	260	310		800										
SL1011A350													135 V		
SL1011B350	280	350	420	800	900										
SL1411A350															
SL1011A470	376 470	0 564 10	1000	1100											
SL1411A470	3/0	+/0	504	1000											
SL1011A500	400	500	600	1100	1200										
SL1011A600	480	600	720	1200	1400										
SL1411A600	100	500	. 20	1200											

Notes:

1. At delivery AQL 0.65 level II, DIN ISO 2859

2. In ionized mode

3. Comparable to the silicon measurement Switching Voltage (Vs)

4. Tested according to ITU-T Rec. K.12 < 150 msecs.

Product Characteristics

Materials	Leaded Device: Nickel-plated with Tin- plated wires Core and Surface Mount: Dull Tin-plated
Product Marking	Littelfuse 'LF' Mark, voltage and date code

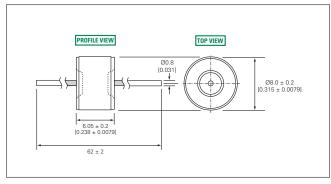
Glow to Arc Transition Current	< 0.5 Amps			
Glow Voltage	~60 Volts			
Storage and Operational Temperature	-40 to +90°C			

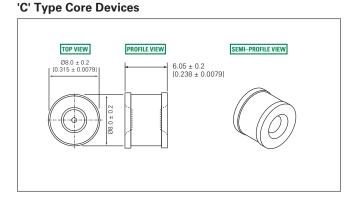


Device Dimensions

For SL1011A/SL1011B series:

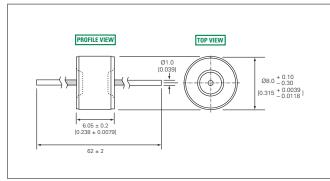
'A' Type Axial Lead Devices



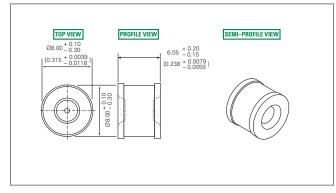


For SL1411A series:

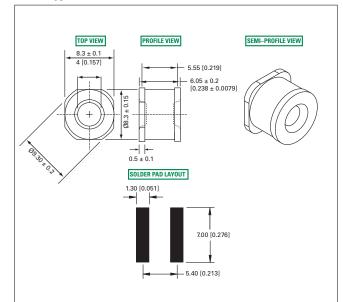
'A' Type Axial Lead Devices



'C' Type Core Devices



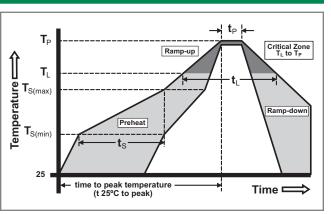
'SM' Type Surface Mount Devices



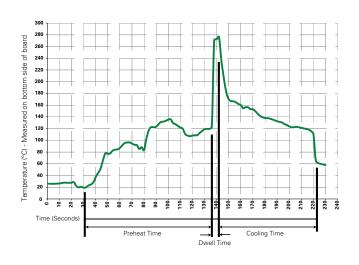


Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb-free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 seconds		
Average R (T _L) to pea	amp-up Rate (LiquidusTemp k)	3°C/second max.		
$T_{S(max)}$ to T_L	- Ramp-up Rate	5°C/second max.		
Reflow	-Temperature (T_L) (Liquidus)	217°C		
	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260 ^{+0/-5} °C		
Time with Temperatu	in 5°C of Actual Peak ıre (t _p)	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max.		
Time 25°C	to Peak Temperature (T _P)	8 minutes max.		
Do not exc	ceed	260°C		



Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation		
Preheat:			
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)		
Temperature Minimum:	100° C		
Temperature Maximum:	150° C		
Preheat Time:	60-180 seconds		
Solder Pot Temperature:	280° C Maximum		
Solder Dwell Time:	2-5 seconds		

Soldering Parameters - Hand Soldering

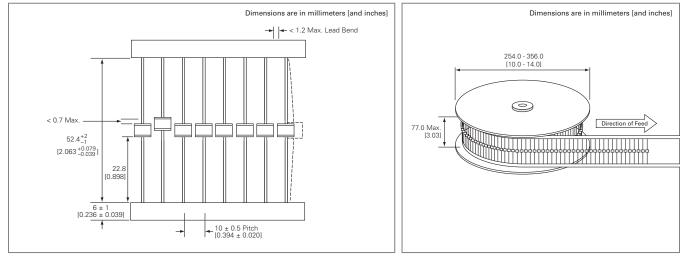
Solder Iron Temperature: 350° C +/- 5°C Heating Time: 5 seconds max.



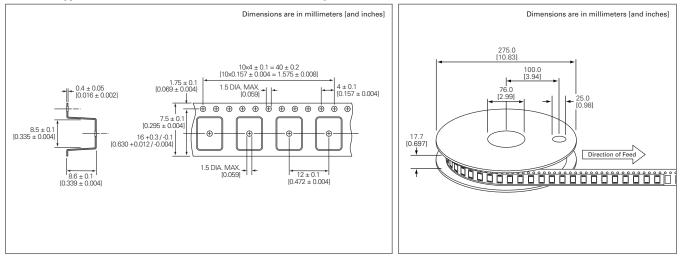
Gas Discharge Tube (GDT) Products SL1011A/B and SL1411A Series

Packaging Dimensions

For 'A' Type Axial Lead Items



For 'SM' Type Surface Mount Items (SL1411A series only)



For 'C' Type Core Items: Packed in plastic bag (500 pcs)



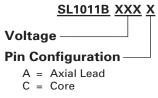
Part Numbering System and Ordering Information

For SL1011A series:

SL1011A XXX X Voltage ______ Pin Configuration _____ A = Axial Lead C = Core

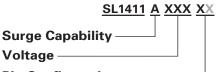
Remarks: Formed leads are available on request

For SL1011B series:



Remarks: Formed leads are available on request

For SL1411A series:



Pin Configuration -

A = Axial Lead C = Core

SM = Surface Mount